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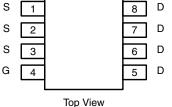


**Vishay Siliconix** 

# N-Channel 100 V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω) Max.	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)			
100	0.0088 at V <sub>GS</sub> = 10 V	18.4				
	0.0094 at V <sub>GS</sub> = 7.5 V	17.8	20.7 nC			
	0.0120 at V <sub>GS</sub> = 4.5 V	15.8				





Si4190ADY-T1-GE3 (Lead (Pb)-free and Halogen-free)

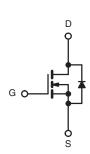
**Ordering Information:** 

#### **FEATURES**

- TrenchFET<sup>®</sup> Power MOSFET
- 100 % Rg and UIS Tested
- Material categorization: COMPLIANT For definitions of compliance please see HALOGEN www.vishay.com/doc?99912 FREE

#### **APPLICATIONS**

- DC/DC Primary Side Switch
- Telecom/Server
- Industrial



N-Channel MOSFET

ABSOLUTE MAXIMUM RATIN				Unit
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	100	V
Gate-Source Voltage		V <sub>GS</sub>	± 20	· ·
	T <sub>C</sub> = 25 °C		18.4	
Continuous Drain Current (T $= 150$ °C)	T <sub>C</sub> = 70 °C	] ,	14.6	
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	13 <sup>b, c</sup>	
	T <sub>A</sub> = 70 °C		10.3 <sup>b, c</sup>	A
Pulsed Drain Current (t = 300 µs)		I <sub>DM</sub>	70	A
Continuous Courses Durin Diada Current	T <sub>C</sub> = 25 °C		5.4	
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	- I <sub>S</sub>	2.7 <sup>b, c</sup>	
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	30	
Avalanche Energy			45	mJ
	T <sub>C</sub> = 25 °C		6	
Maximum Power Dissipation	T <sub>C</sub> = 70 °C		3.8	w
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3 <sup>b, c</sup>	VV
	T <sub>A</sub> = 70 °C		1.9 <sup>b, c</sup>	
Operating Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 10 s	R <sub>thJA</sub>	33	42	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	16	21	- 0/10		

Notes:

a. Based on  $T_C = 25$  °C.

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b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under steady state conditions is 85 °C/W.

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### Vishay Siliconix



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static		•					
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = 250 \mu A$	100			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L 050		64		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	- I <sub>D</sub> = 250 μΑ		- 5.8			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	1.5		2.8	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zarra Cata Maltaga Drain Current	I <sub>DSS</sub>	$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	μA	
Zero Gate Voltage Drain Current		$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	30			Α	
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 15 A		0.0073	0.0088		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 7.5 V, I <sub>D</sub> = 12 A		0.0078	0.0094		
		V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 10 A		0.0096	0.0120		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 15 A		54		S	
Dynamic <sup>b</sup>		•					
Input Capacitance	C <sub>iss</sub>			1970		pF	
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0 V, f = 1 MHz		695			
Reverse Transfer Capacitance	C <sub>rss</sub>			62			
Total Gate Charge		$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 10 \text{ A}$		44.4	67		
	Q <sub>g</sub>			20.7	31	nC	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 10 \text{ A}$		6.1			
Gate-Drain Charge	Q <sub>gd</sub>			9.1			
Output Charge	Q <sub>oss</sub>	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}$		56	85		
Gate Resistance	R <sub>g</sub>	f = 1 MHz	0.4	1.1	2.2	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			15	30		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 50 V, $R_L$ = 5 $\Omega$		11	22	-	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong$ 10 A, $V_{GEN}$ = 7.5 V, $R_g$ = 1 $\Omega$		31	60		
Fall Time	t <sub>f</sub>			10	20	20	
Turn-On Delay Time	t <sub>d(on)</sub>			12	24	- ns - -	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 50 V, $R_L$ = 5 $\Omega$		10	20		
Turn-Off Delay Time	t <sub>d(off)</sub>	$\text{I}_\text{D}\cong$ 10 A, $\text{V}_\text{GEN}$ = 10 V, $\text{R}_\text{g}$ = 1 $\Omega$		34	65		
Fall Time	t <sub>f</sub>			10	20		
Drain-Source Body Diode Characteristic	cs						
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			5.4	•	
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			1	70	A	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 5 A		0.76	1.1	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			42	80	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$\frac{1}{1}$		40	80	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = 10 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^\circ\text{C}$		19			
Reverse Recovery Rise Time	t <sub>b</sub>	1		23		ns	

Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %

b. Guaranteed by design, not subject to production testing.

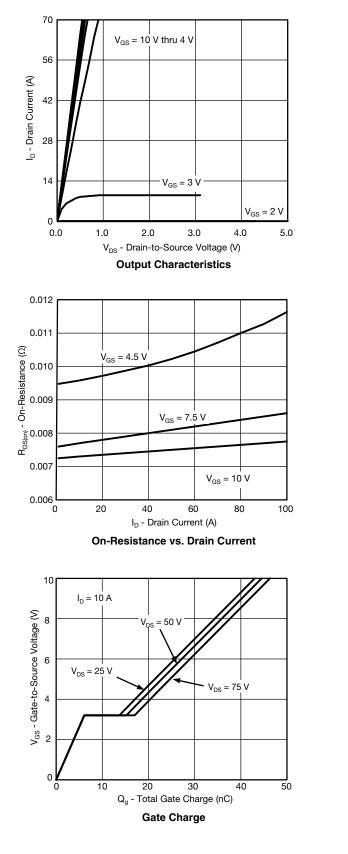
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

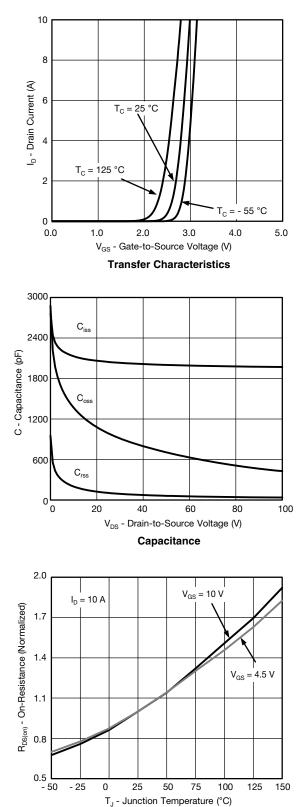
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**On-Resistance vs. Junction Temperature** 

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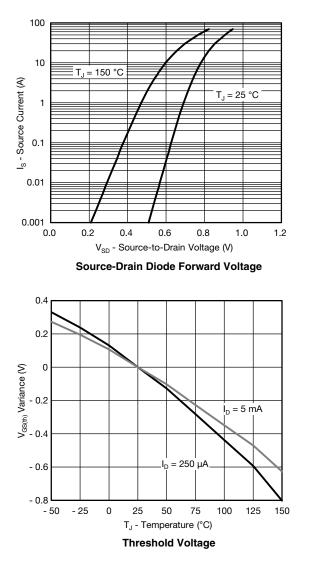
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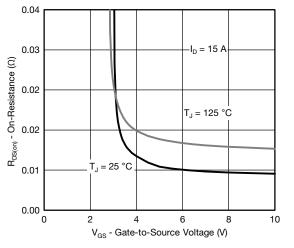
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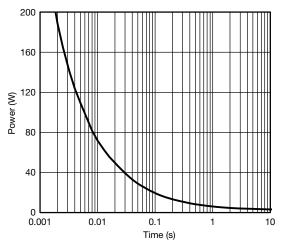


#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

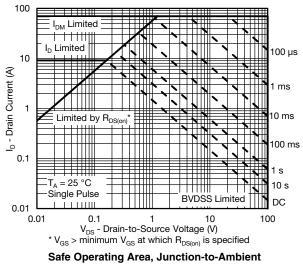




**On-Resistance vs. Gate-to-Source Voltage** 



Single Pulse Power, Junction-to-Ambient



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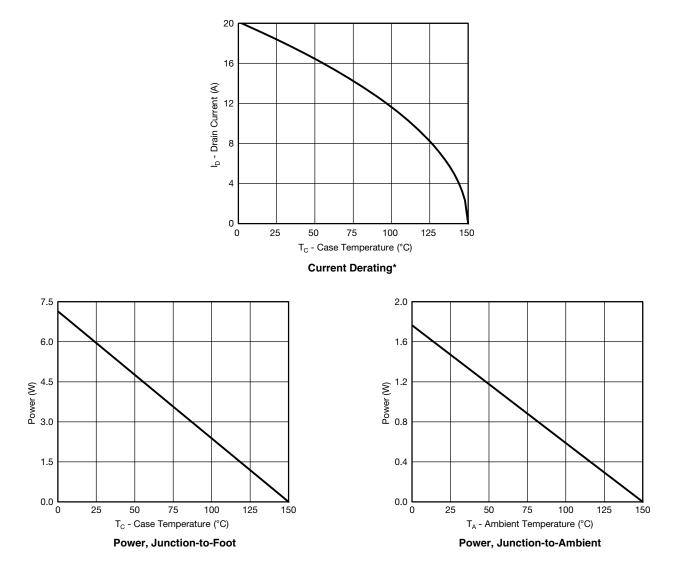
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### Si4190ADY Vishay Siliconix

#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

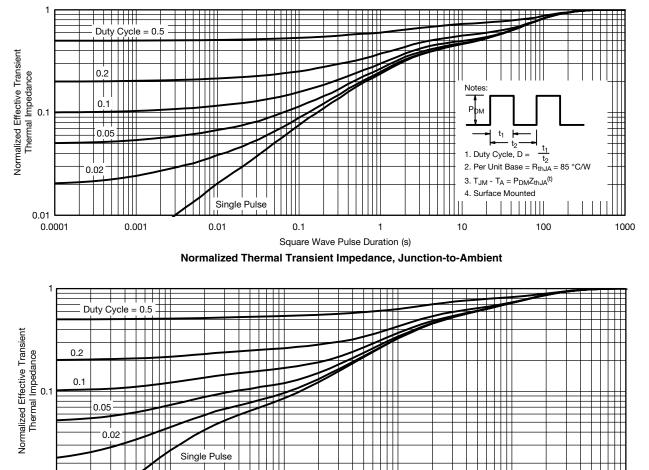


\* The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

#### **Vishay Siliconix**



#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



0.001 0.01 0.1 1 Square Wave Pulse Duration (s)

Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg?63826</u>.

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# Package Information

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# SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INCHES		
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					

# **Application Note 826**

Vishay Siliconix



**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)

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